

PE632BA

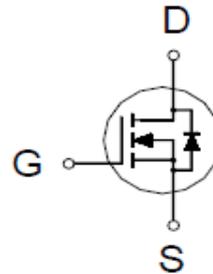
N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D |
|---------------|------------------------|-------|
| 30V | 4.5mΩ @ $V_{GS} = 10V$ | 53A |



PDFN 3X3P



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|--|-----------------------|----------------|------------|-------|
| Drain-Source Voltage | | V_{DS} | 30 | V |
| Gate-Source Voltage | | V_{GS} | ±20 | V |
| Continuous Drain Current ² | $T_C = 25\text{ °C}$ | I_D | 53 | A |
| | $T_C = 100\text{ °C}$ | | 33 | |
| | $T_A = 25\text{ °C}$ | | 15 | |
| | $T_A = 70\text{ °C}$ | | 12 | |
| Pulsed Drain Current ¹ | | I_{DM} | 100 | |
| Avalanche Current | | I_{AS} | 37.5 | |
| Avalanche Energy | $L = 0.1\text{mH}$ | E_{AS} | 70 | mJ |
| Power Dissipation | $T_C = 25\text{ °C}$ | P_D | 22.7 | W |
| | $T_C = 100\text{ °C}$ | | 9 | |
| | $T_A = 25\text{ °C}$ | | 2 | |
| | $T_A = 70\text{ °C}$ | | 1.3 | |
| Operating Junction & Storage Temperature Range | | T_J, T_{stg} | -55 to 150 | °C |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|----------------------------------|-----------------|---------|---------|--------|
| Junction-to-Ambient ³ | $R_{\theta JA}$ | | 63 | °C / W |
| Junction-to-Case | $R_{\theta JC}$ | | 5.5 | |

¹Pulse width limited by maximum junction temperature.

²Package limitation current is 23A.

³The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25\text{ °C}$.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

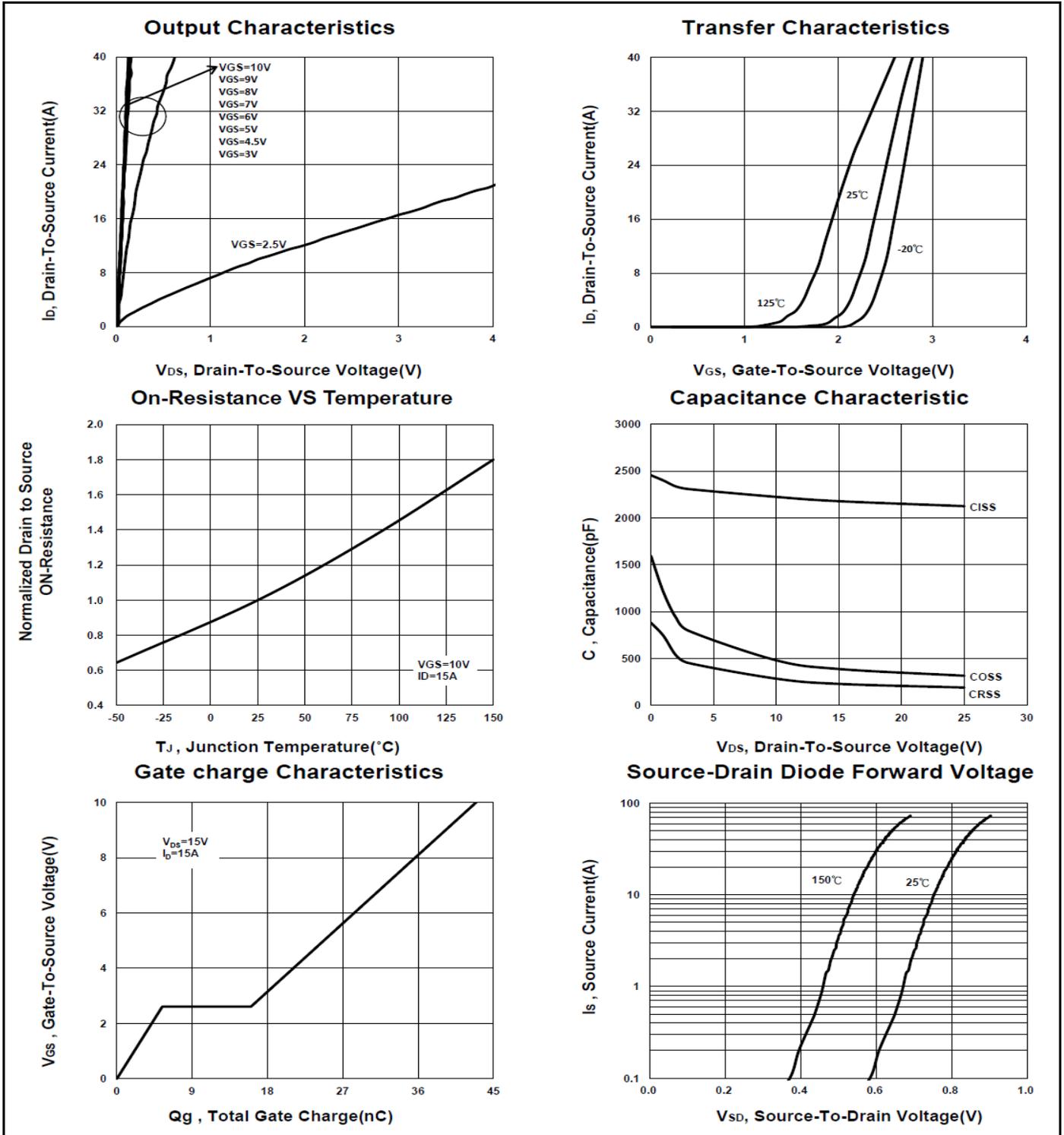
| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNITS |
|---|--------------------------|--|---|------|------|-------|
| | | | MIN | TYP | MAX | |
| STATIC | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = 250μA | 30 | | | V |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250μA | 1.3 | 1.7 | 2.3 | |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0V, V _{GS} = ±20V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 24V, V _{GS} = 0V | | | 1 | μA |
| | | V _{DS} = 20V, V _{GS} = 0V, T _J = 125 °C | | | 10 | |
| Drain-Source On-State Resistance ¹ | R _{DS(ON)} | V _{GS} = 4.5V, I _D = 15A | | 4 | 5.5 | mΩ |
| | | V _{GS} = 10V, I _D = 15A | | 3.3 | 4.5 | |
| Forward Transconductance ¹ | g _{fs} | V _{DS} = 5V, I _D = 15A | | 60 | | S |
| DYNAMIC | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0V, V _{DS} = 15V, f = 1MHz | | 2210 | | pF |
| Output Capacitance | C _{oss} | | | 390 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 234 | | |
| Gate Resistance | R _g | V _{GS} = 0V, V _{DS} = 0V, f = 1MHz | | 1.4 | | Ω |
| Total Gate Charge ² | Q _{g(VGS=10V)} | V _{DS} = 15V, I _D = 15A | | 44.1 | | nC |
| | Q _{g(VGS=4.5V)} | | | 23 | | |
| Gate-Source Charge ² | Q _{gs} | | | 6 | | |
| Gate-Drain Charge ² | Q _{gd} | | | 13 | | |
| Turn-On Delay Time ² | t _{d(on)} | | V _{DD} = 15V, I _D ≅ 15A, V _{GEN} = 10V, R _G = 6Ω | | 25 | |
| Rise Time ² | t _r | | | 15 | | |
| Turn-Off Delay Time ² | t _{d(off)} | | | 54 | | |
| Fall Time ² | t _f | | | 17 | | |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C) | | | | | | |
| Continuous Current | I _S | | | | 22.7 | A |
| Forward Voltage ¹ | V _{SD} | I _F = 15A, V _{GS} = 0V | | | 1 | V |
| Reverse Recovery Time | t _{rr} | I _F = 15A, di _F /dt = 100A / μS | | 26.7 | | nS |
| Reverse Recovery Charge | Q _{rr} | | | 12.9 | | nC |

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

²Independent of operating temperature.

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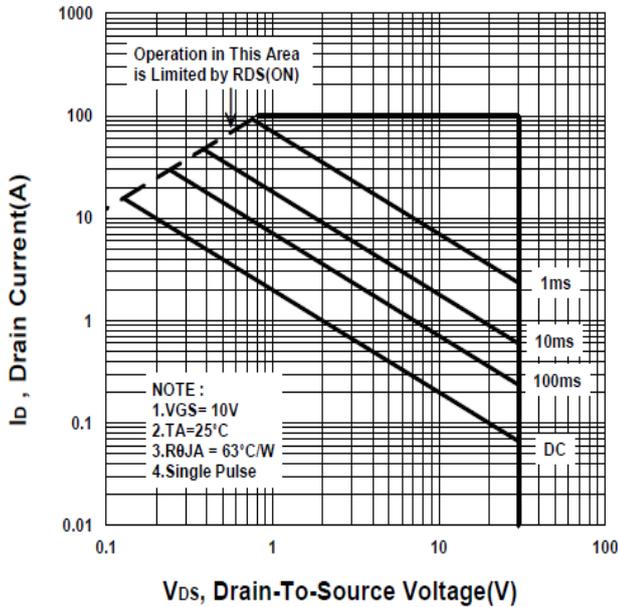
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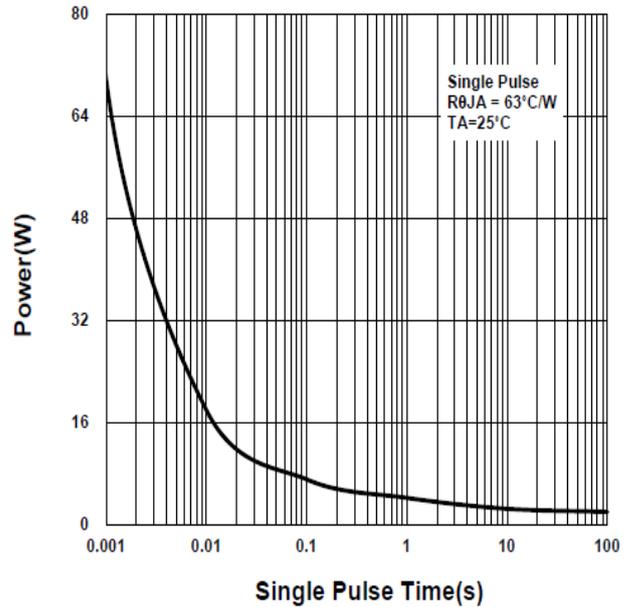
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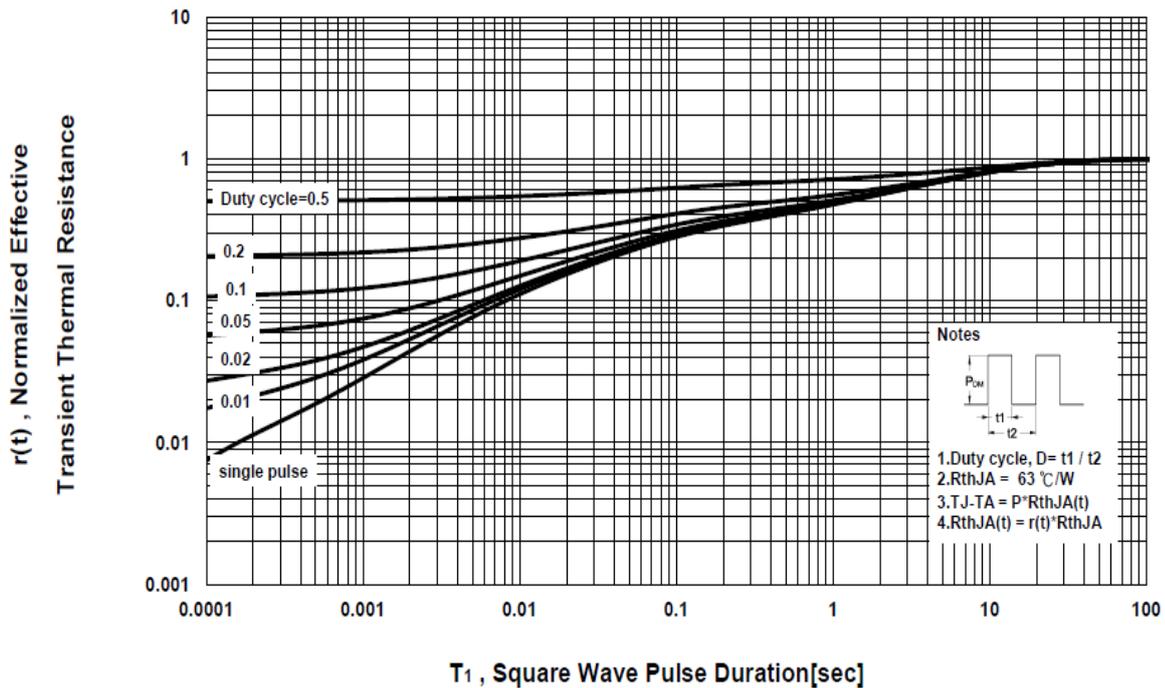
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



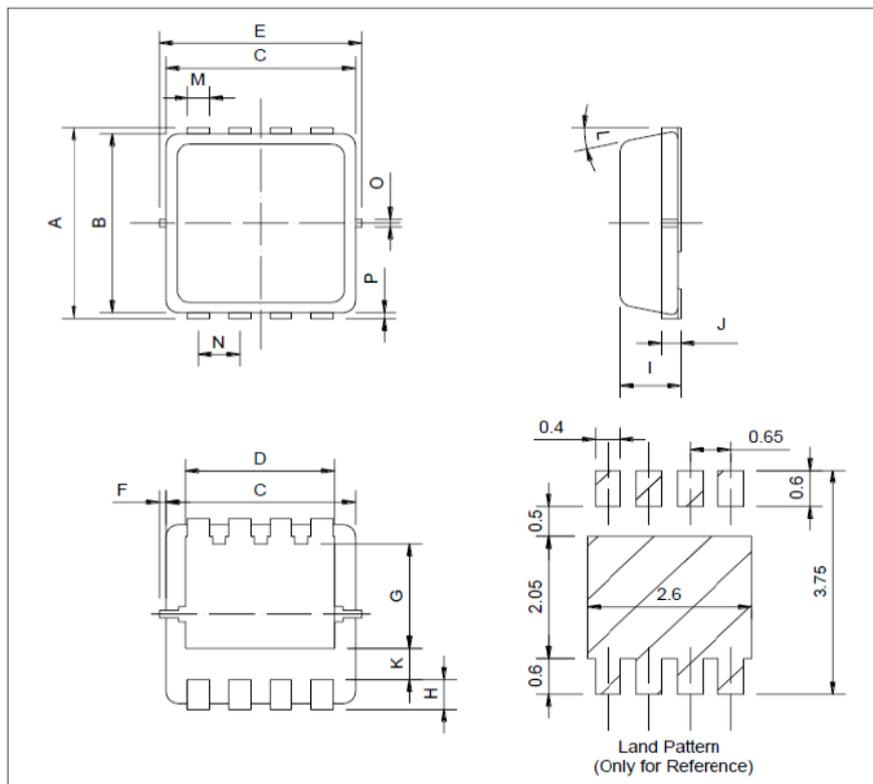
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Package Dimension

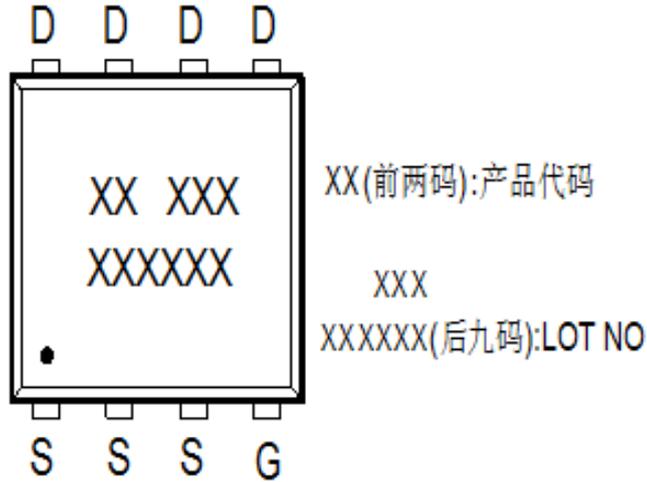
PDFN 3x3P MECHANICAL DATA

| Dimension | mm | | | Dimension | mm | | |
|-----------|------|------|-------|-----------|------|------|------|
| | Min. | Typ. | Max. | | Min. | Typ. | Max. |
| A | 3 | | 3.6 | I | 0.7 | | 1.12 |
| B | 2.88 | | 3.2 | J | 0.1 | | 0.33 |
| C | 2.9 | | 3.2 | K | 0.6 | | |
| D | 1.98 | | 2.69 | L | 0° | 10° | 12° |
| E | 3 | | 3.6 | M | 0.14 | | 0.41 |
| F | 0 | | 0.455 | N | 0.6 | | 0.7 |
| G | 1.47 | | 2.2 | O | 0.12 | | 0.36 |
| H | 0.15 | | 0.56 | P | 0 | | 0.2 |

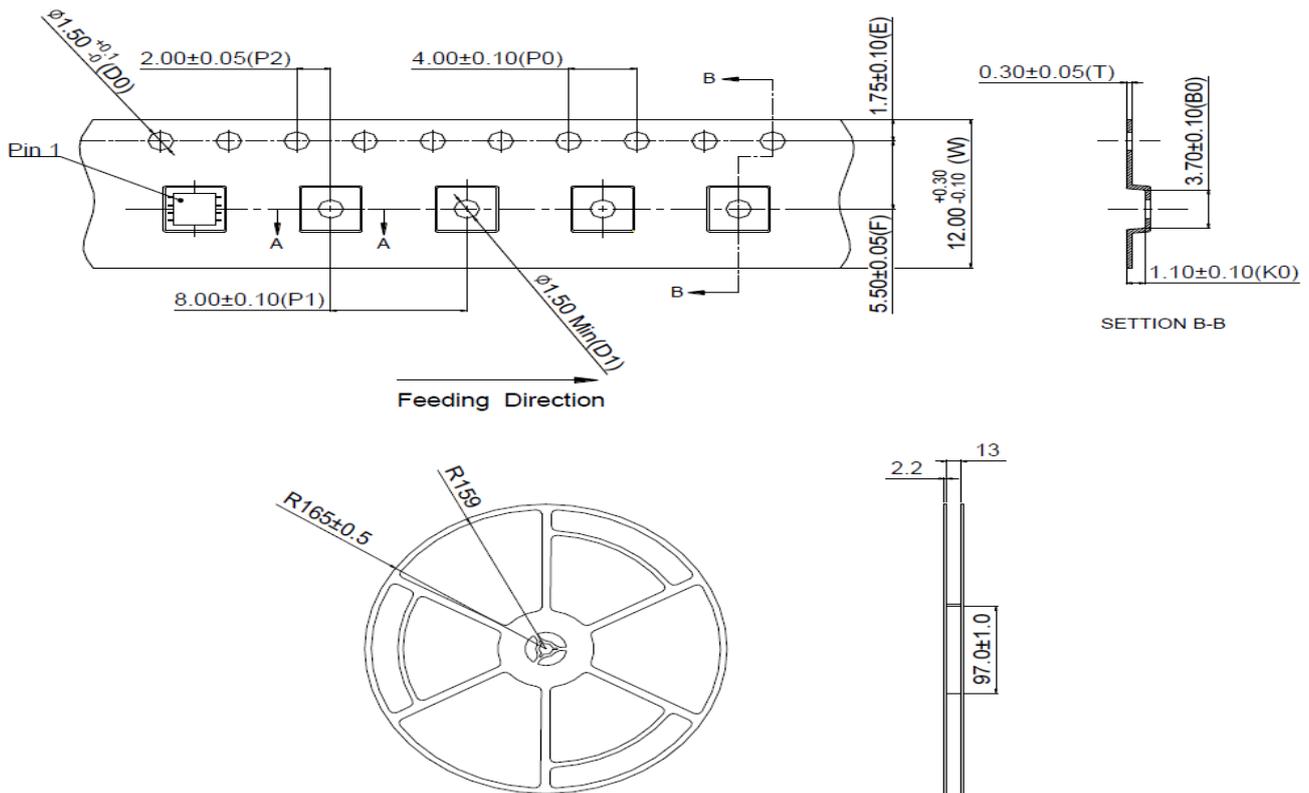


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A. Marking Information(此产品代码为: H5)



B. Tape&Reel Information:5000pcs/Reel

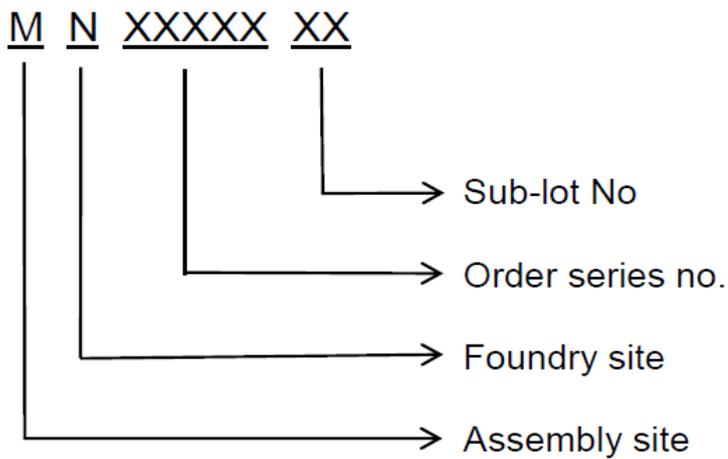


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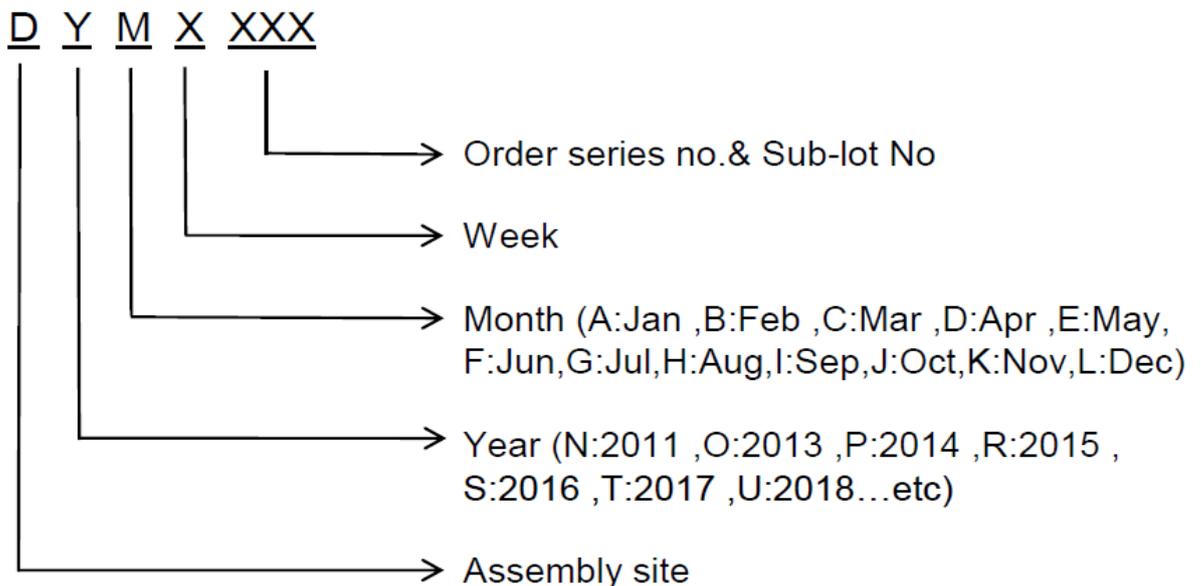
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C. Lot No.&Date Code rule

1.Lot No.



2.Date Code



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D.Label rule

标签内容(Label content)



| | | |
|----|--------------------|---|
| 1 | Label Size | 30 * 90 mm |
| 2 | Font style | Times New Roman or Arial (或可区分英文”0”和数字”0”，”G和”Q”的字型即可) |
| 3 | Great Power | Height: 4 mm |
| 4 | Package | Height: 2 mm |
| 5 | Date | Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12 |
| 6 | Device | Height: 3 mm (Max: 16 Digit) |
| 7 | Lot | Height: 3 mm (Max: 9 Digit) Sub lot |
| 8 | D/C | Height: 3 mm (Max: 7 Digit) |
| 9 | QTY | Height: 3 mm (Max: 6 Digit) Thousand mark is no needed |
| 10 | Pb Free label |  Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial |
| 11 | Halogen Free label |  Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial |
| 12 | Scan info | Device / Lot / D/C / QTY , Insert “ / “ between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least |